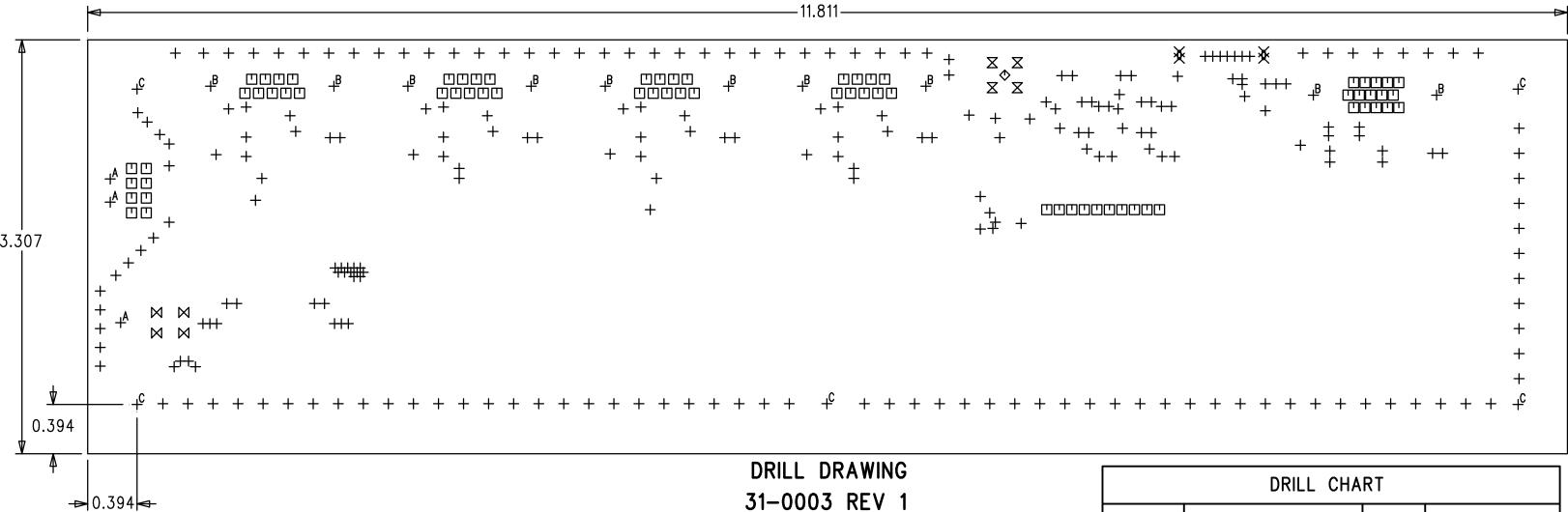


SILKSCREEN
31-0003 REV 1

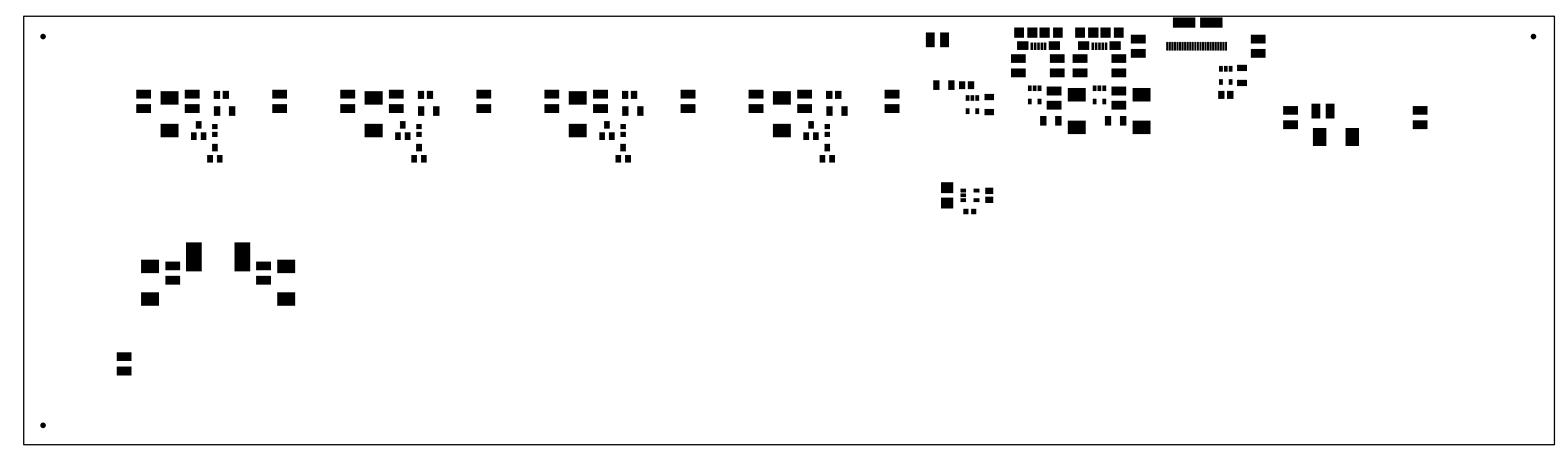


NOTES:

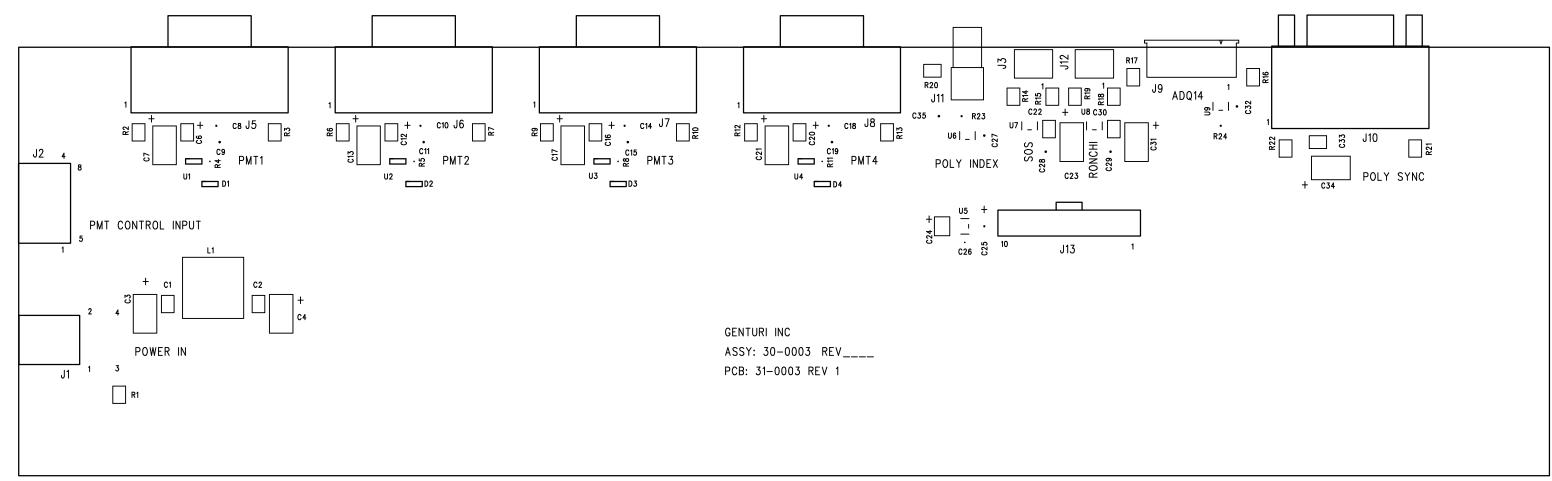
- 1. MAT'L: 0.062 THK. FR4 COPPERCLAD LAMINATE.
- 2. ALL HOLES TO BE PLATED THRU WITH A MINIMUM WALL THICKNESS OF 0.001.
- 3. BOARDS TO BE LPIOBC ON BOTH SIDES GREEN COLOR.
- 4. BOARDS TO BE ENIG FINISH AFTER SOLDERMASK.
- 5. BOARDS TO BE SILKSCREENED ON TOP SIDE WITH PERMANENT, WHITE EPOXY (CHEMICAL AND SCRATCH RESISTANT).
- 6. BOARDS TO BE ELECTRICALLY TESTED FOR SHORTS AND OPENS.
- 7. BOARDS SHALL BE MADE FROM UNDERWRITER LABORATORY RECOGNIZED MATERIAL AND THE FINISHED BOARD MUST CARRY THE VENDOR'S U.L. LOGO AND DATE CODE.
- 8. ALL DRAWINGS AND FILMS VIEWED FROM TOP SIDE.

| 0.001. | 1 OZ. COPPERCLAD |
|---|--------------------------|
| 062 +/-10% | PRIOR TO PLATING |
| | TOP SIDE |
| .028 —> | GROUND LAYER POWER LAYER |
| <u>, , , , , , , , , , , , , , , , , , , </u> | BOTTOM SIDE |
| | 1 OZ. COPPERCLAD |
| | PRIOR TO PLATING |
| 1 OZ | . CU. INNER LAYERS |

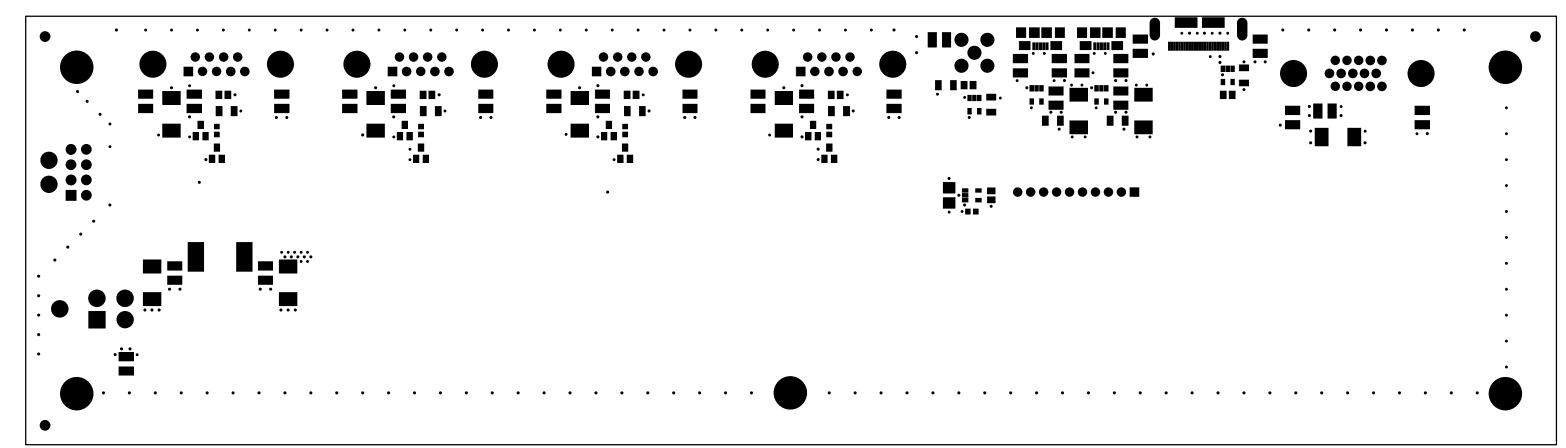
| DRILL CHART | | | |
|-------------|-----------------------------|-----|-------------|
| SYMBOL | SIZE | QTY | PLATED TYPE |
| + | 0.015 +0/-0.005 | 254 | PLATED |
| × | 0.024 X 0.075 SLOT +/-0.003 | 2 | PLATED |
| | 0.043 +/-0.003 | 69 | PLATED |
| ♦ | 0.059 +/-0.003 | 1 | PLATED |
| X | 0.063 +/-0.003 | 4 | PLATED |
| × | 0.071 +/-0.003 | 4 | PLATED |
| Α | 0.118 +/-0.003 | 3 | NON-PLATED |
| В | 0.126 +/-0.003 | 10 | PLATED |
| С | 0.157 +/-0.003 | 5 | PLATED |



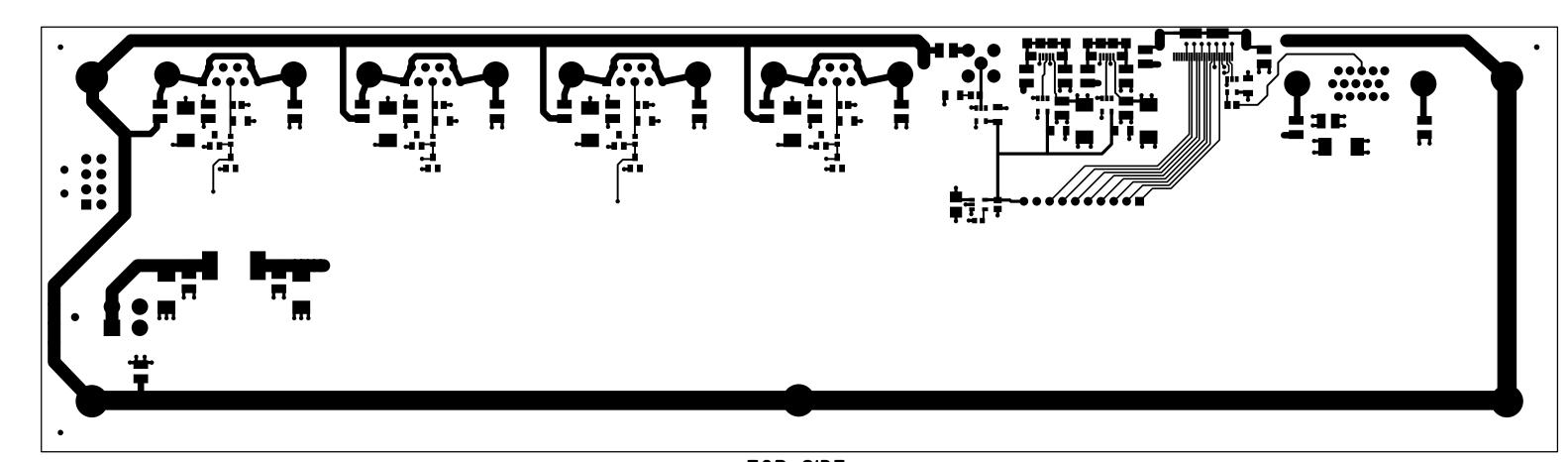
SOLDERPASTE
31-0003 REV 1



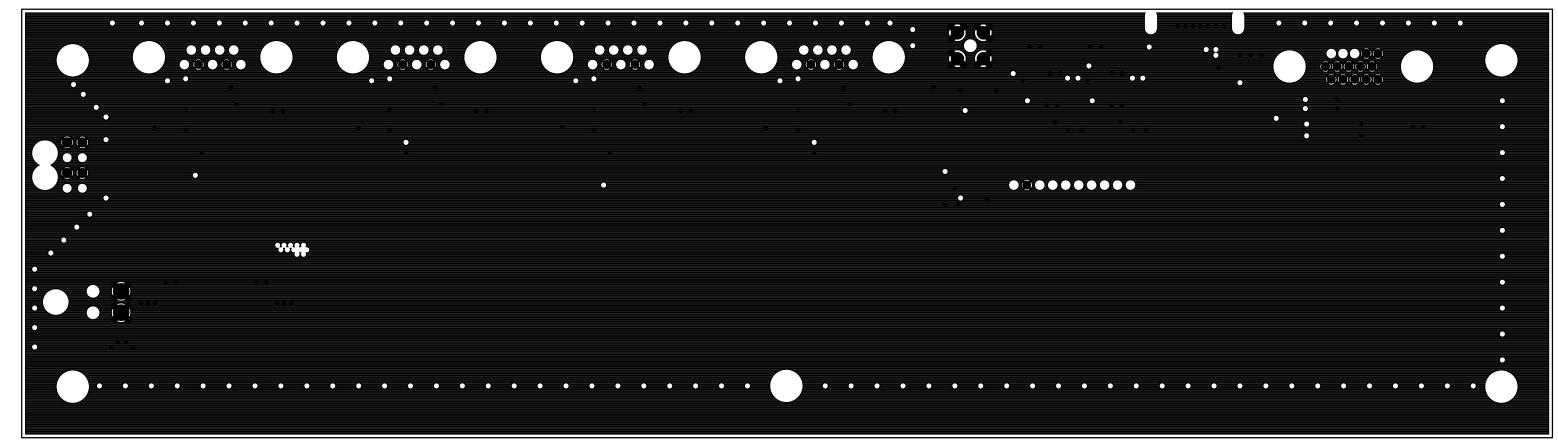
SILKSCREEN 31-0003 REV 1



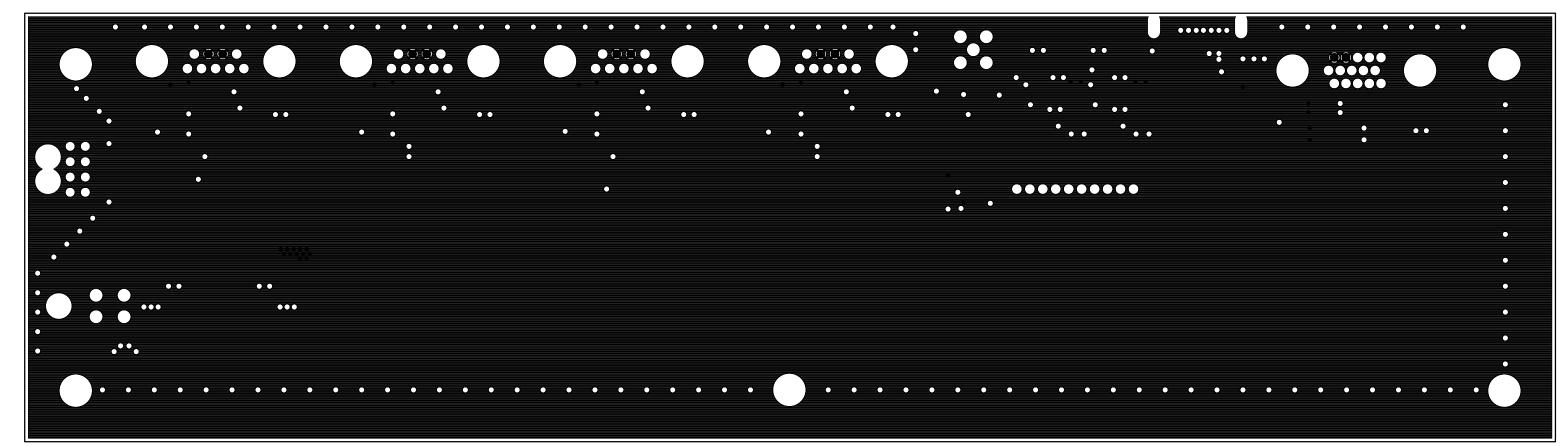
SOLDERMASK TOP SIDE 31-0003 REV 1



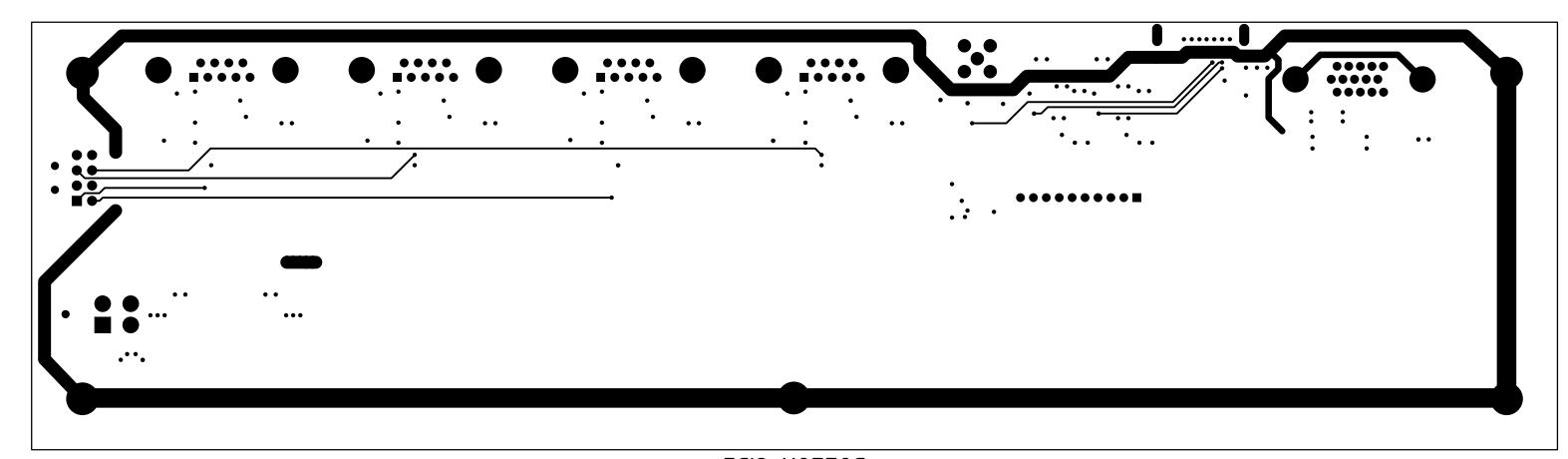
TOP SIDE 31-0003 REV 1



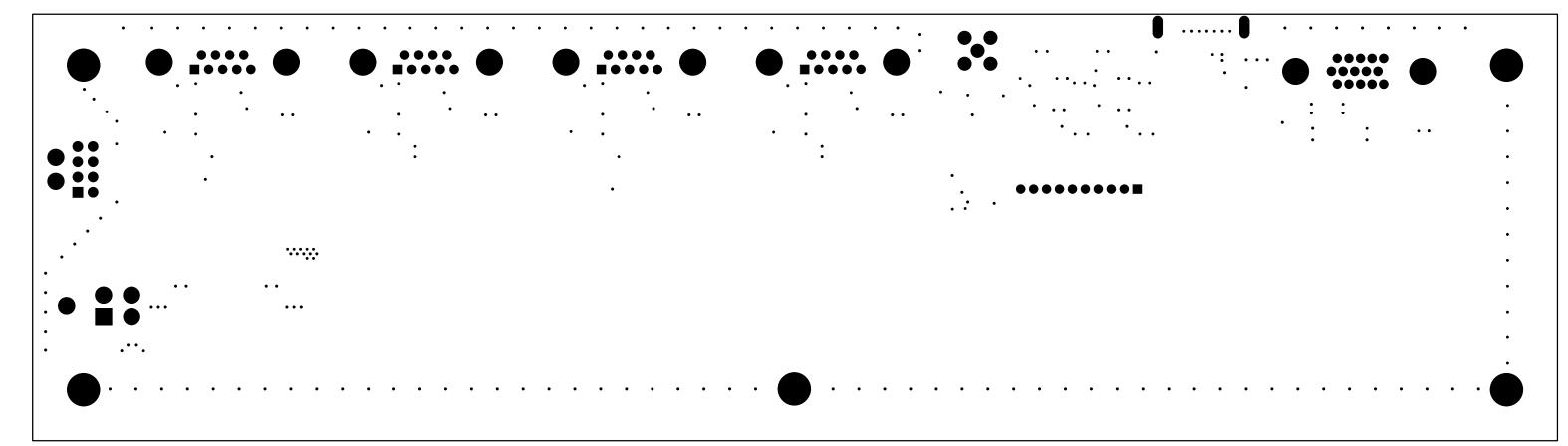
LAYER 2 GROUND 31-0003 REV 1



LAYER 3 POWER 31-0003 REV 1



BOTTOM SIDE 1 V3R E000-1E



SOLDERMASK BOTTOM SIDE 1 V3R 8000-18